APPLICA	BLE STAN	DARD									
RATING OPERATING TEMPERATUR		E RANGE	1010 70 0510 (1075 1)		STORAGE TEMPERATURE RANGE		GE	-10°C TO + 60°C (NOTE 2)			
	OPERATING HUMIDITY RANGE		40% TO + 80%	%	STORAGE HUMIDITY RA		ANGE 40% T0 + 70		40% TO + 70% (NO)%(NOTE 2)	
	VOLTAGE		250V AC				VOLTAGE		30V AC		
	CURRENT		AWG 22 TO 26 : AWG 28 : AWG 30 :	2A 1A 0. 5A	RATIN		CURREI	NT	AWG 22 : AWG 24 TO 28 :	2A 1A 0. 5A	
				IFICAT	ION:	S			7		
	 ГЕМ		TEST METHOD	11 10/ (1			F	REQU	IREMENTS	QT	AT
	RUCTION	ı									1
GENERAL EX	CAMINATION	VISUALLY	Y AND BY MEASURING INSTRUMENT.			ACCORDING TO DRAWING.				X	X
MARKING		CONFIRM	MED VISUALLY.							X	X
ELECTR	IC CHARA	CTERI	STICS		•					•	
	RESISTANCE	100mA	00mA (DC OR 1000 Hz).			30mΩ	2 MAX.			Х	
INSULATIO RESISTANO		500V DC.			1	0001	MΩ MIN.			X	-
VOLTAGE F	ROOF	650V A	C FOR 1 min.	OR 1 min.			NO FLASHOVER OR BREAKDOWN.				-
MECHAI	VICAL CHA	RACTI	ERISTICS		•					•	
MECHANICAL OPERATION		30 TIMES INSERTIONS AND EXTRACTIONS.			-	 CONTACT RESISTANCE: 30mΩ MAX. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 			Х	_	
VIBRATION			REQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE .75 mm, AT 2 h, FOR 3 DIRECTIONS.			1 NO ELECTRICAL DISCONTINUITY OF 1 µs. 2 NO DAMAGE, CRACK OR LOOSENESS			X	_	
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.				OF PARTS.			X	_	
ENVIRO	NMENTAL		ACTERISTICS							_	-
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55 \rightarrow 5 TO 35 \rightarrow +85 \rightarrow 5 TO 35 °C TIME 30 \rightarrow 5 TO 15 \rightarrow 30 \rightarrow 5 TO15 min UNDER 5 CYCLES.			nin ②	 CONTACT RESISTANCE: 30mΩ MAX. INSULATION RESISTANCE: 1000MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				X	-
DAMP HEAT (STEADY STATE)		EXPOSE	OSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.			 CONTACT RESISTANCE: 30mΩ MAX. INSULATION RESISTANCE: 500MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				Х	_
COUN	IT D	SCRIPTI	ON OF REVISIONS		ESIGNE	ΞD			CHECKED	DA	ATE
1	DI		DIS-H-008540 M1. SA		I. SAKIMU				HK. UMEHARA		02. 26
							APPRO		TS. SAKATA	+	06. 03
								ECKED TS. FUKUSHIMA SIGNED TH. YOSHIZAWA		+	06. 03
							DESIG		TH. YOSHTZAWA YK. NAKATSU	+	05. 30 05. 27
Note QT:Qualification Test AT:Ass			urance Test X:Applicable Test D		DRA'	RAWING NO.		VIN	ELC4-314124-01		ου, <i>Δ1</i>
нs			-					D	DF11CZ-*DS-2V (22)		
110			LECTRIC CO., LTD.	С	ODE N	: NO. CL543		CL543	Δ	1/2	

	SPECIFICATIO	NS		
ITEM	TEST METHOD	REQUIREMENTS	QT	АТ
RESISTANCE TO SOLDERING HEAT	1) AUTOMATIC SOLDERING (REFLOW) 《REFLOW AREA》 MAX 250°C WITHIN 10 sec. MIN 230°C WITHIN 60 sec. 《PREHEATING AREA》 150 TO 180°C 90 TO 120 sec. PUT THROUGH IN REFROW FUMACE TWICE. FEAVE IN AMBIENT TEMPERATURE AND HUMIDITY FOR 1 HOUR. CONNECTOR TEMPERATURE TO BE AMBIENT FOR SECOND REFLOW. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE :290±10°C, SOLDERING TIME :3s. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	×	
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 230±5°C FOR IN IMMERSION, DURATION, 3 s.	A NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	X	

REMARKS

NOTE 1:INCLUDING THE TEMPERATURE RISE BY CURRENT.

NOTE 2:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD , AFTER PCB BOARD , OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERM STORAGE DURING TRANSPORTATION.

NOTE 3:THE TEMPERATURE PROFILE SHALL BE APPLIED WITHIN 168 HOURS AFTER OPENING MOISTURE-PROOF PACKAGING. WHEN 168 HOURS PASSED AFTER OPENING , APPLY THE BOTTOM REQUIREMENTS.

《REFLOW AREA》

MAX 240°C WITHIN 10 sec. MIN 230°C WITHIN 60 sec. 《PREHEATING AREA》

150 TO 180°C 90 TO 120 s.

Unless otherwise specifid, refer to IEC 60512.

Note QT:Qı	ualification Test AT:Assurance Test X:Applicable Test	DRAWIN	IG NO.	ELC4-314124-01		
HRS	SPECIFICATION SHEET	PART NO.	DF11CZ-*DS-2V(22)			
11.	HIROSE ELECTRIC CO., LTD.	CODE NO		CL543	4	2/2